
Multi-source Agreement (MSA) of 10 Gbit/s Miniature Device (XMD)

XMD14

Physical Interface of LC ROSA Type 2 Package

**Rev. 1.2
January 17, 2006**

Description

This technical document has been created by the XMD MSA committee. This document is offered to both users and suppliers of 10Gbit/s compact optical sub-assembly (OSA) modules as a basis for a technical agreement. However, it is not a warranted document. Each OSA supplier will have its own datasheet. If the users wish to find a warranted document, they should consult the datasheet of the chosen OSA supplier.

The MSA committee reserves the rights at any time to add, amend or withdraw technical data contained in this document.

Revision

| Revision | Date | Purpose/ changes |
|----------|------------------|--|
| 1.0 | September 1,2004 | First public issue |
| 1.1 | October29, 2005 | Changes to unify the descriptions in ROSA Type1 and Type2 Package documents. |
| 1.2 | January 17, 2006 | Changes document name to identify connector type Adds reference |

1 Scope

The XMD MSA committee has created this technical document to specify the physical interface of LC ROSA type 2 package. The specifications were based on the investigation mainly assuming a planar type as the type 2 package.

2 Reference Documents

[1] IEC 61754-20
“Fibre optic connector interfaces – Part 20: Type LC connector family”

[2] XMD12
“Electrical & Optical Interfaces of ROSA APD”

3 Abbreviations

| | |
|------|--|
| APD | Avalanche photo diode |
| FPC | Flexible printed circuit |
| OSA | Optical sub-assembly |
| PCB | Printed circuit board |
| ROSA | Receiver optical sub-assembly |
| TOSA | Transmitter optical sub-assembly |
| XFP | 10 gigabit small form factor pluggable |

4 Electrical Interface

4.1 Numbering of electrical terminals

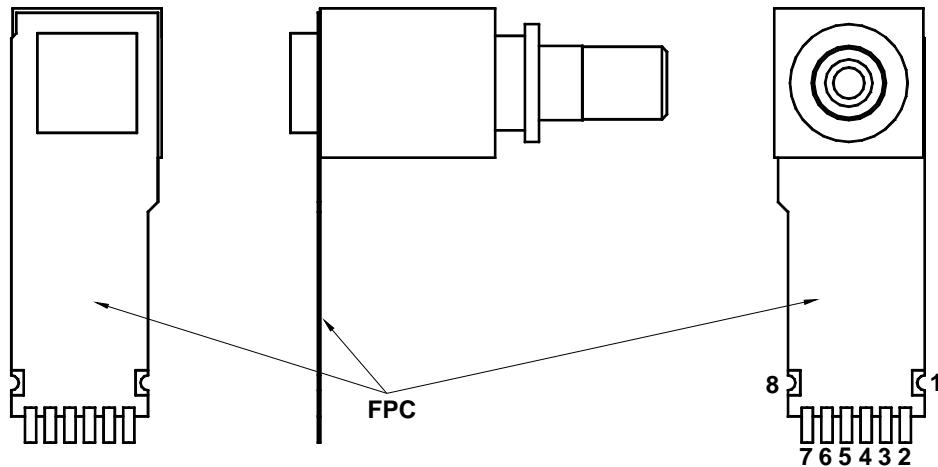


Fig. 1 Electrical terminal numbering assignments

Note 1: The FPC structure in this figure is prepared as an example only. The vendor should specify its FPC structure based on the mechanical interface in Session 5. The electrical terminal numbering assignments shall be defined by the pattern layout in Figure 3.

4.2 Electrical terminal assignment

Table 1 Terminal function definitions

| Terminal number | Function |
|-----------------|--------------------|
| 1 | Thermistor |
| 2 | Vcc |
| 3 | Signal Ground |
| 4 | Out |
| 5 | OutB |
| 6 | Signal Ground |
| 7 | No User Connection |
| 8 | Vapd |

Note 1: Package potential shall be specified by each vendor.

Note 2: Definitions of "Out" and "OutB can be obtained in the references [2].

5 Mechanical interface

5.1 Package outline

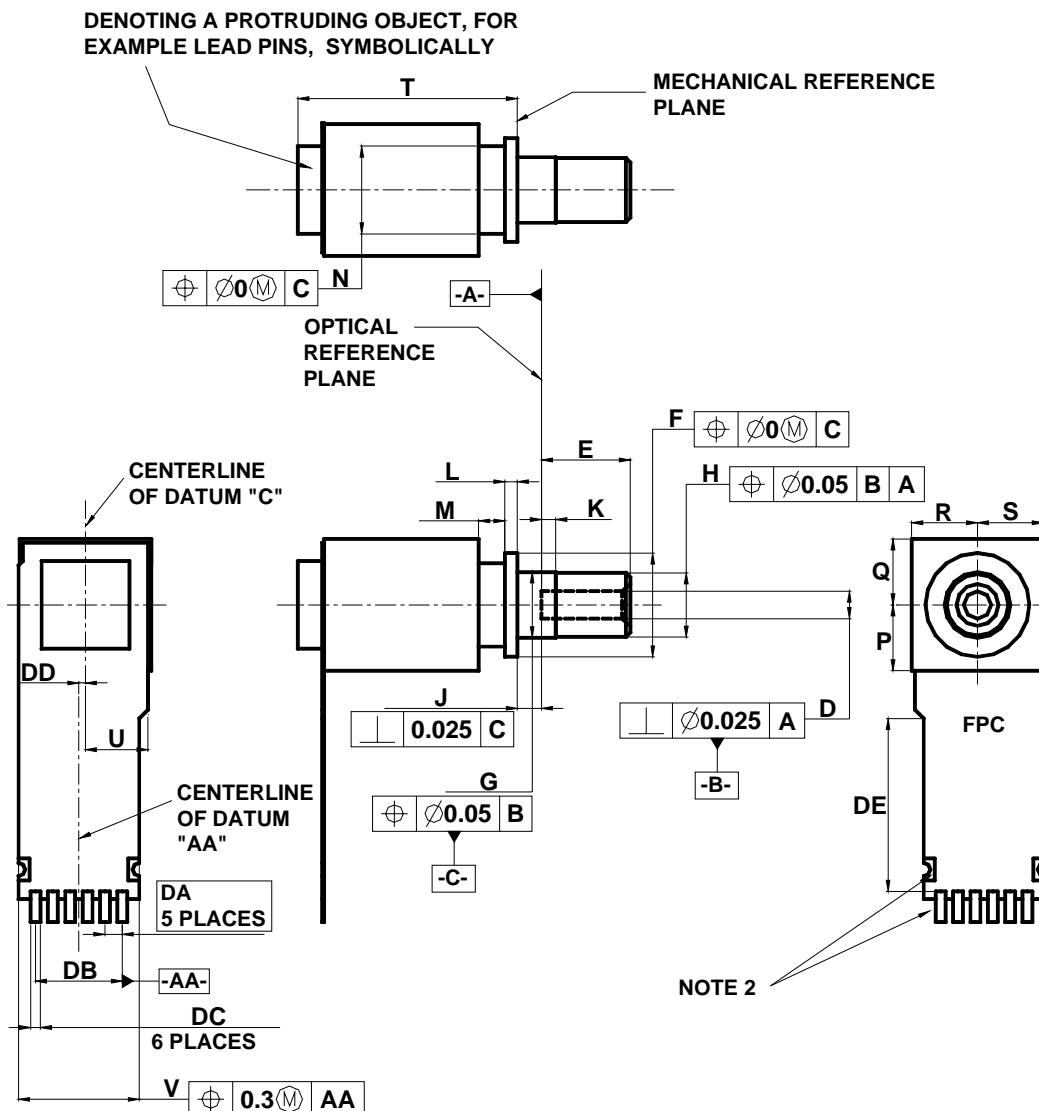


Fig. 2 Package outline drawing

Note 1: The attachment structure of the FPC to the ROSA body shall be specified by each vendor to comply with the recommended pattern layout described in Figure 3. The structure described here is prepared as an example only.

Note 2: Denoting 8 soldering pads corresponding to the terminals described in Figure 1 and Table 1. Features and dimensions of the pads and the FPC end portion shape around the pads shall be specified by each vendor to comply with the recommended pattern layout described in Figure 3. The features of the pads and the FPC end portion shape described in this figure are prepared as examples only.

Note 3: The vendor should design the FPC by considering electrical crosstalk and mechanical stress.

Table 2 Dimensions of the package outline

| Reference | Dimensions mm | | Notes |
|-----------|------------------|---------|-----------------------------|
| | Minimum | Maximum | |
| D | - | - | Note 1 |
| E | 4.0 | 4.1 | |
| F | 4.7 | 5.1 | Diameter |
| G | 2.98 | 3.00 | Diameter |
| H | - | 2.97 | Diameter |
| J | 1.065 | 1.135 | |
| K | 0.55 | 0.70 | |
| L | 0.52 | 0.63 | |
| M | 1.0 | - | |
| N | - | 4.1 | Diameter |
| P | - | 3 | Note 2 |
| Q | - | 3 | Note 2 |
| R | - | 3 | Note 2 |
| S | - | 3 | Note 2 |
| T | - | 13 | Note 3 |
| U | - | 3 | Note 4, Note 5 |
| V | - | 5.7 | Note 5 |
| DA | 0.79 | | Basic dimension, Note 5 |
| DB | 3.95 | | Reference dimension, Note 5 |
| DC | - | - | Note 6 |
| DD | 0.05 | 0.55 | Note 5, Note 7 |
| DE | 2.5 | - | Note 5 |

Note 1: Refer IEC 61754-20.

Note 2: P, Q, R and S only define the maximum dimension, thus do not specify the shape of the package.

Note 3: The dimension T shall be specified by each vendor considering their designed FPC attachment structure and the recommended pattern layout described in Figure 3.

Note 4: Denoting the outline dimension of the FPC from the datum "C".

Note 5: The dimensions defined in this table shall be satisfied, even if a vendor should choose the different FPC attachment structure or the different FPC end portion shape from those described in Figure 2.

Note 6: The dimension and the positional tolerance of "DC" shall be specified by each vendor considering the recommended pattern layout described in Figure 3.

Note 7: Denoting the dimension from the centerline of the datum "C" to the centerline of the datum "AA".

5.2 Recommended pattern layout

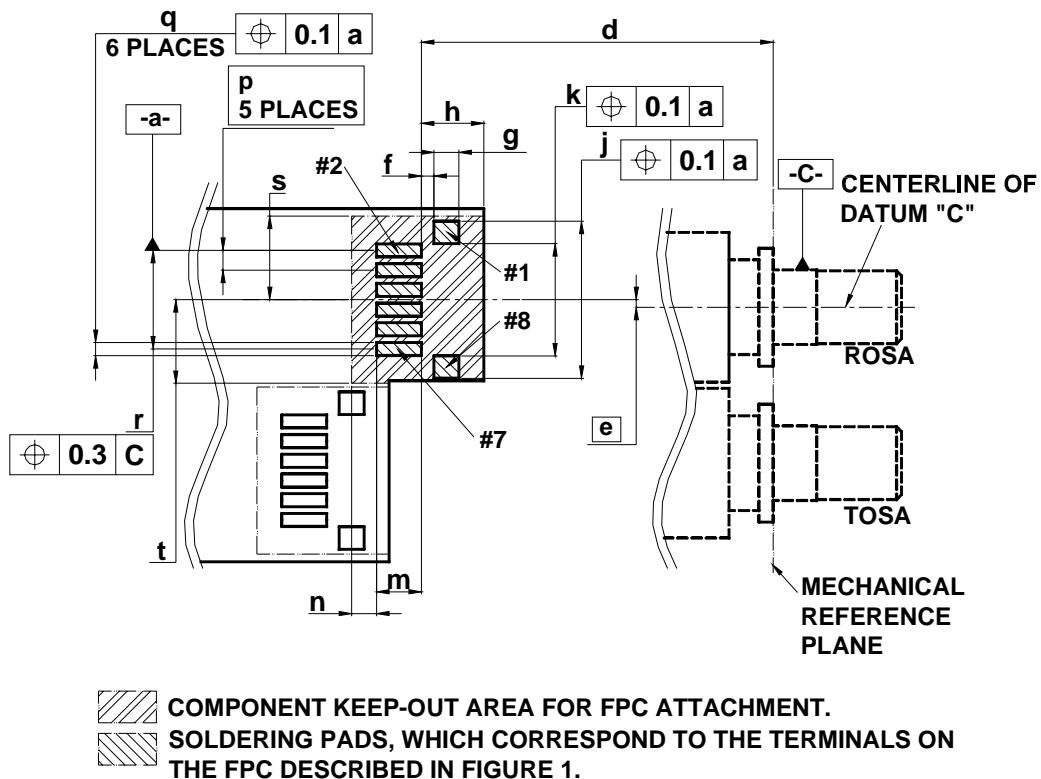


Fig. 3 Recommended pattern layout for the PCB in a XFP transceiver

Note 1: The datum "C" described here is the same one as described in Figure 2.

Note 2: #1, #2, #7 and #8 in this figure are denoting pad numbers corresponding to the terminal numbers described in Figure 1 and Table 1.

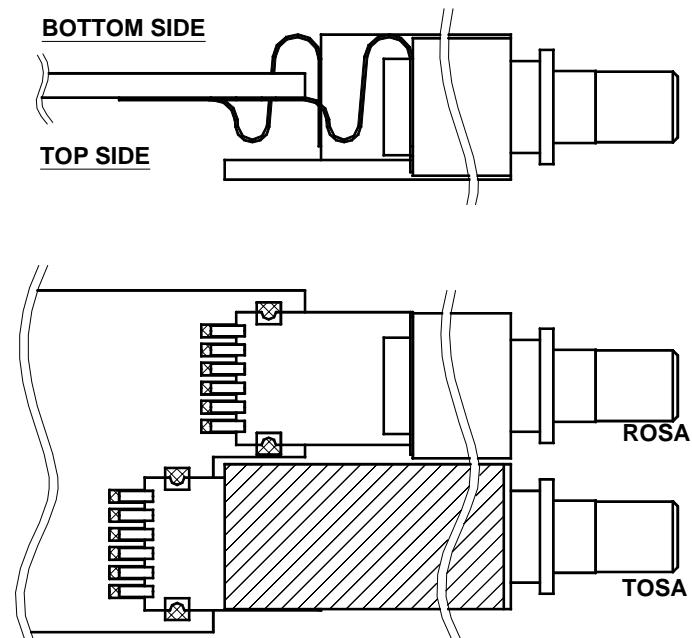


Fig. 4 Recommended arrangement of the PCB, FPCs, TOSA and ROSA

Note 1: The soldering pads for FPC attachment shall be prepared on the top side of the PCB as described here. The bending shape of the FPC shall be specified by each vendor. The FPC bending shape described here is prepared as an example only.

Table 3 Dimensions of the recommended pattern layout for the PCB

| Reference | Dimensions | | Notes |
|-----------|------------|------|-------------------------|
| | mm | mm | |
| d | 17.7 | 18.4 | |
| e | 0.3 | | Basic dimension, Note 1 |
| f | 0.50 | 0.55 | |
| g | 1.0 | 1.1 | |
| h | - | 2.5 | |
| j | 6.10 | 6.35 | |
| k | 4.45 | 4.55 | |
| m | 1.4 | - | |
| n | 1.0 | - | |
| p | 0.79 | | Basic dimension |
| q | 0.45 | 0.50 | |
| r | 3.95 | | Reference dimension |
| s | 3.35 | - | Note 2 |
| t | 3.35 | - | Note 2 |

Note 1: Denoting the offset between the datum "C" and the datum "a".

Note 2: Denoting the dimension from the datum "a".